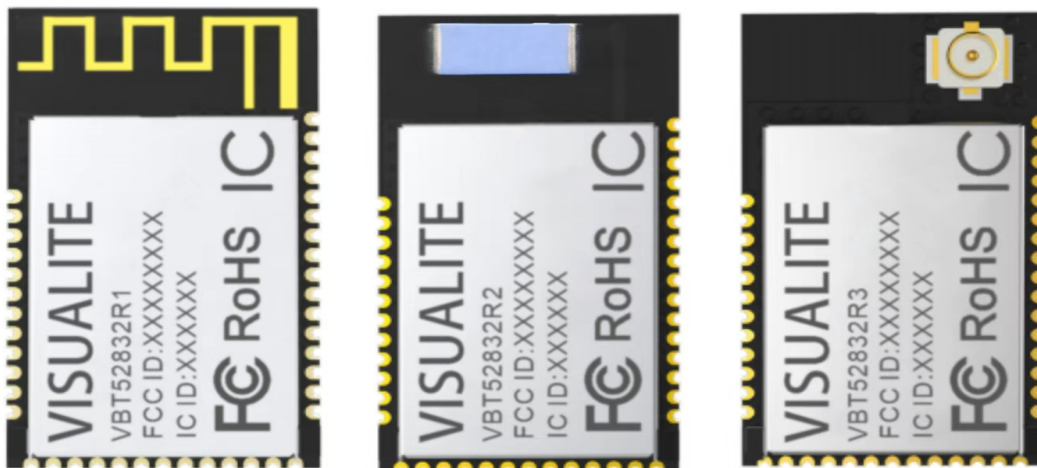


Visualite

Bluetooth LE Module

VB52832R1



Datasheet

V 1.0.0

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Visualite Technology Enterprise
(ShenZhen)LTD

Version Note

Version	Details	Contributor(s)	Date	Notes
1.0.0	First edit	Michelle	2025.12.01	

Part Numbers

Model	Hardware Code
VB52832R1	1Y32AI
VB52832R2	2Y32AI
VB52832R3	3Y32AI



VTB52832R1-nRF52832

Fully-certified, leads to 30 I/O ports, cost-effective Bluetooth 5.4 module

The VTB52832R1 is an RF transceiver using the nRF52832 which has an ARM core Cortex-M4F, the MCU has a faster operating speed, with the core running at up to 64Mhz. 512KB of FLASH program space, 64KB of RAM and other powerful supporting resources. It is suitable for low-power systems, ultra-low sleep current and low power consumption during operation.

FEATURES



Bluetooth 5.4



Fully certified



Leads to 30 I/O ports



High quality-price ratio

KEY PARAMETER

VT52832R1-nRF52832

Chip Model	nRF528321	Antenna	PCB/Ceramic/IPEX
Module Size	20×12×2.3mm	GPIO	30
Flash	512KB	RAM	64KB
Receiving Sensitivity	-96dBm	Transmission Power	-40 ~ +4dBm
Current(TX)	0dBm-5.3mA	Current(RX)	5.4mA

APPLICATION



Smart
Buildings



Consumer
Electronics



Intelligent
Medical care



Smart
Agriculture



Security
Equipment



Automotive
Equipment

CERTIFICATION



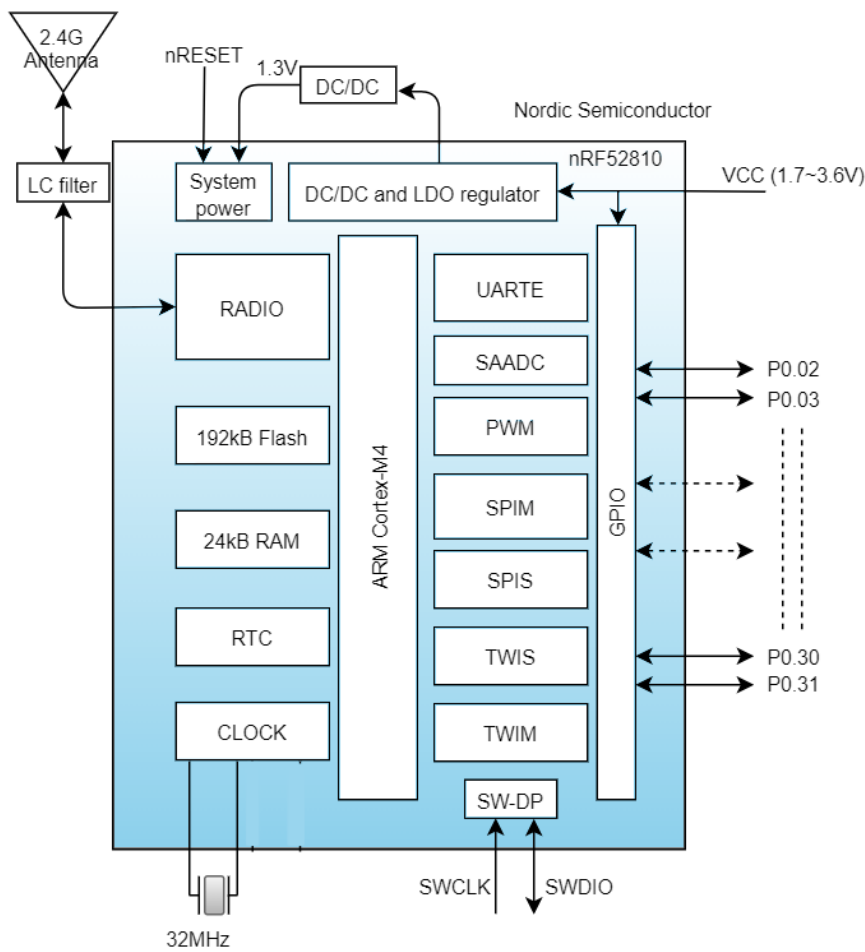
IC

RoHS

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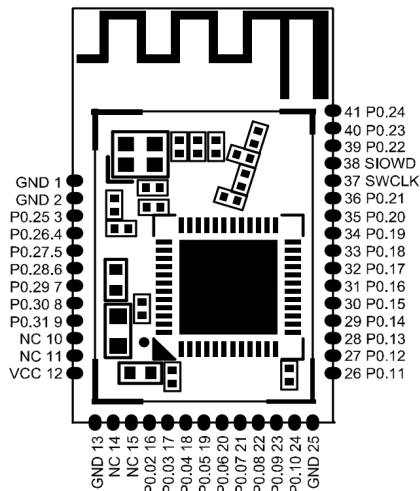
1 BLOCK DIAGRAM



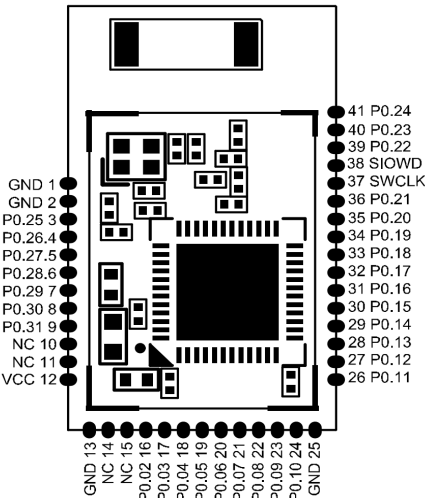
2 ELECTRICAL SPECIFICATION

Parameters	Value	Notes
Working Voltage	1.7V-3.6V	To ensure RF work, supply voltage suggest not lower than 2.3V
Working Temperature	-40℃~+85℃	Storage temperature is -40℃~+125℃
Transmission Power	-40 ~ +4dBm	Configurable
Current(RX)	5.4mA	RF receiving current under 1Mbps pattern
Current(TX)	5.3mA	RF transmission current under 0dBm pattern
Module Dimension	20*12*2.3mm	
Quantity of IO Port	30	

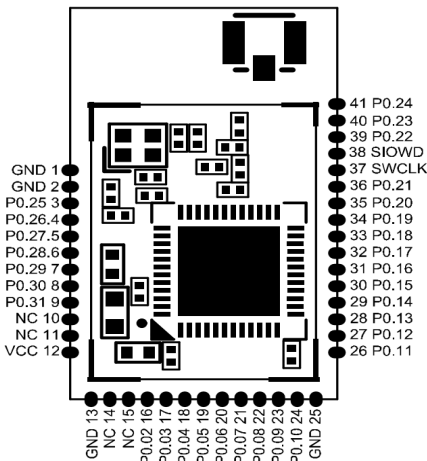
3PIN DESCRIPTION



PCB Antenna



Ceramic Antenna



IPEX Antenna

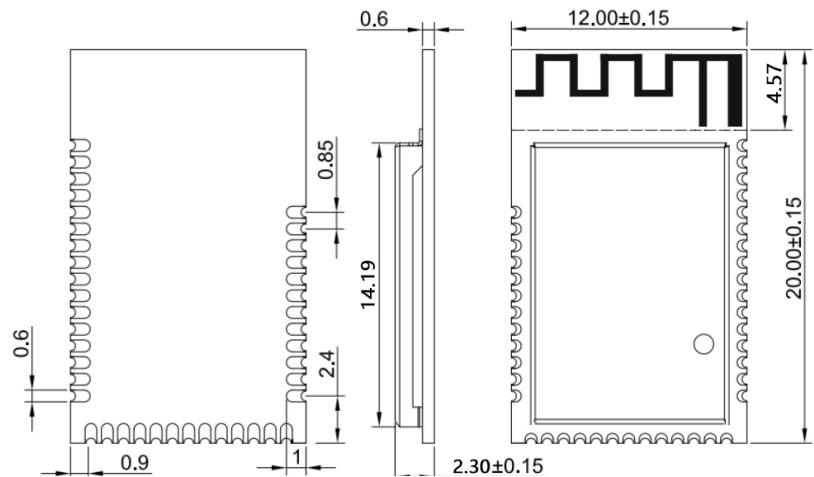
4PIN DEFINITION

Pin Number	Symbol	Type	Definition
12	VCC	VCC	Power source
1/2/13/25	GND	Ground	Ground
38	SWDIO	SWDIO	Burn data pins
37	SWCLK	SWCLK	Burn-in Clock Pins
3-9/16-24/26-36/39-41	P0.00 to P0.31	GPIO	GPIOs, of which P0.02, P0.03, P0.04, P0.05, P0.28, P0.29, P0.30, P0.31 are analog input pins that can be used as ADCs

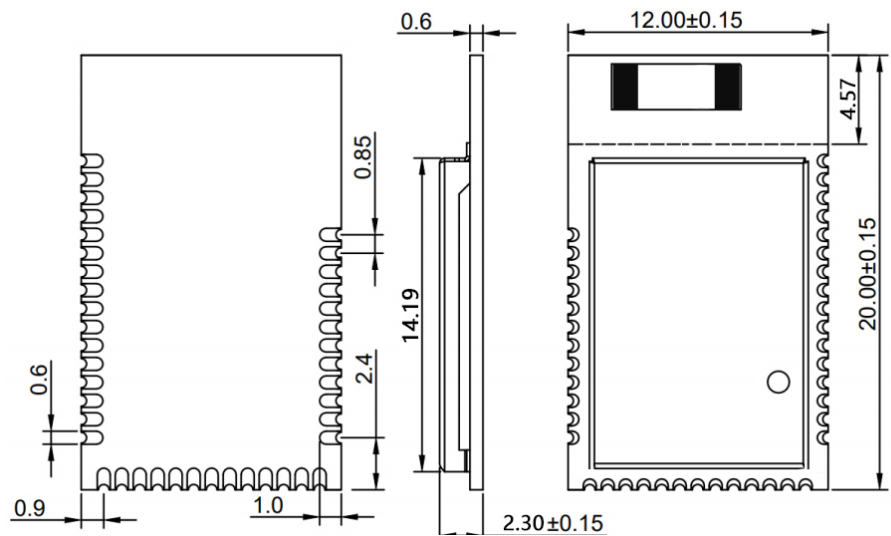


5 MECHANICAL DRAWING

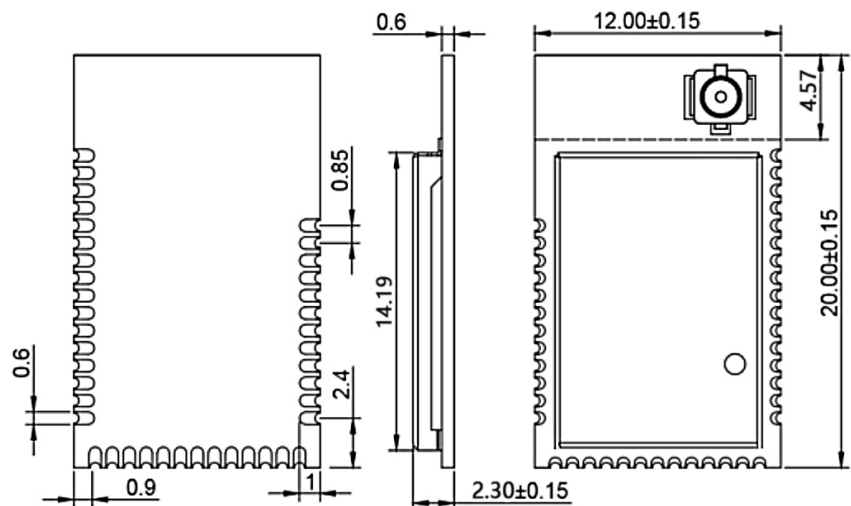
PCB Antenna



Ceramic Antenna



IPEX Antenna

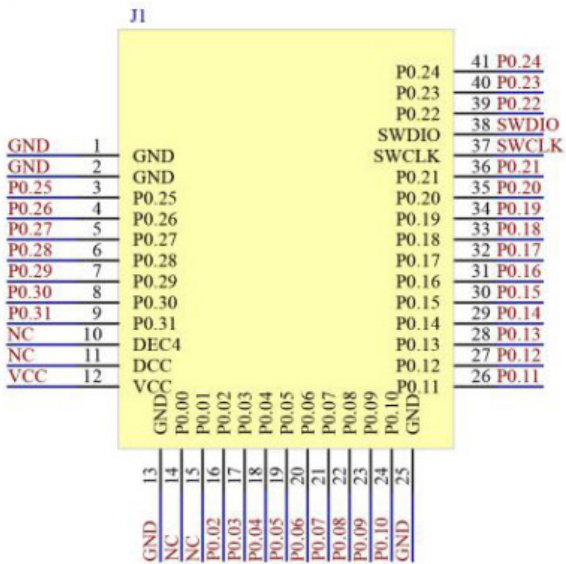
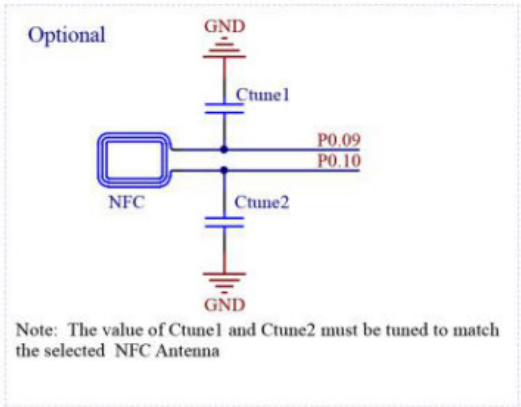
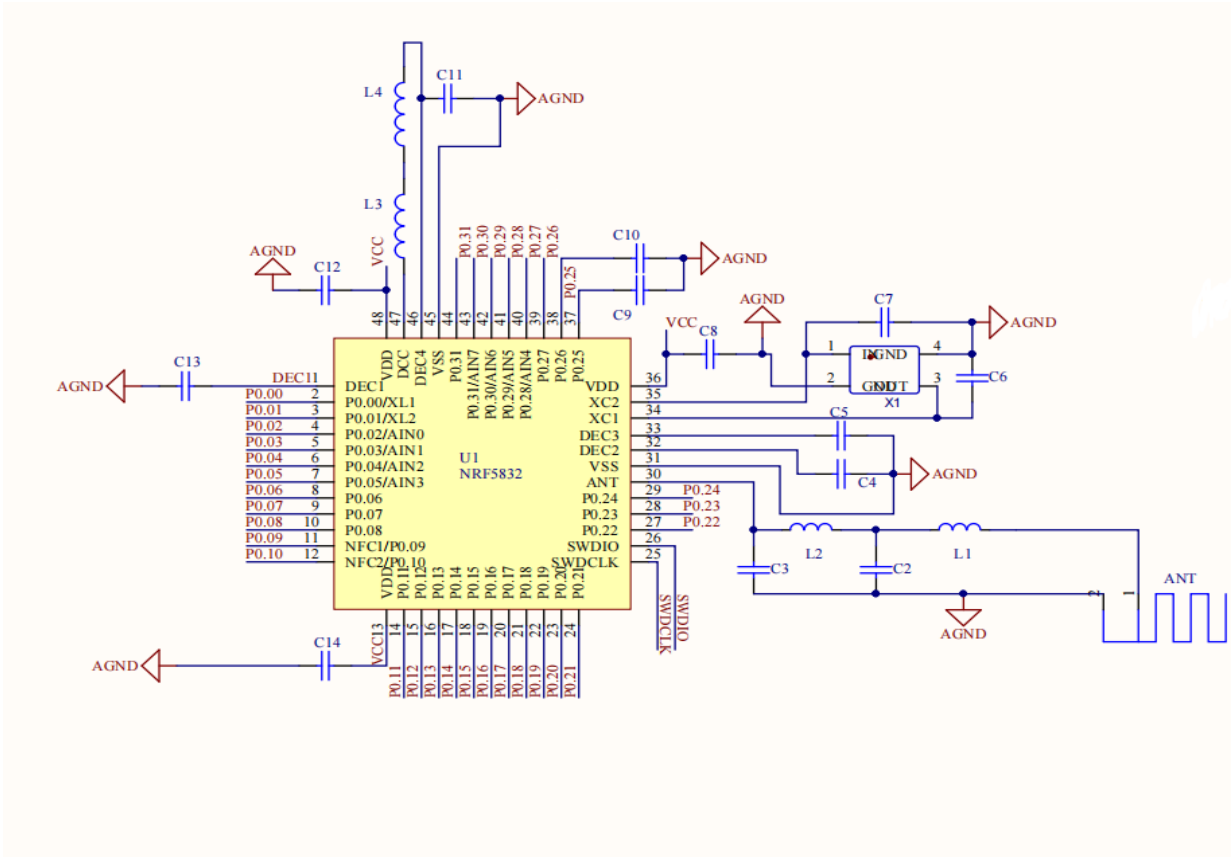


Default unit: mm Default tolerance: ± 0.15



Notice: The recommended pad size is 1.7*0.6mm with a pad extension of 0.5mm

6 ELECTRICAL SCHEMATIC



Notice: Before placing an order, please confirm the specific configuration required with the salesperson.

7 PCB LAYOUT

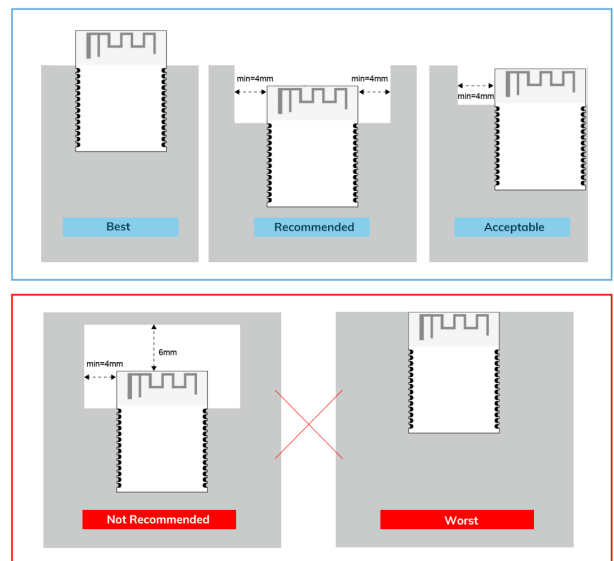
There should be no GND plane or metal cross wiring in the module antenna area, and no components should be placed nearby. It is best to make a hollow or clear area, or place it on the edge of the PCB board. The reference example is as follows:



Notice: It is strongly recommended to use the first design method. The module antenna design is debugged according to the first wiring.

Layout Notes:

- 1) The module's antenna area should be completely clear of any metal obstructions to avoid affecting antenna performance (as shown in the diagram).
- 2) Outside the module's antenna area, try to maintain a solid copper pour to minimize interference from the mainboard signal lines or other sources.
- 3) A clear area of at least 4mm should surround the module's antenna (including its casing) to reduce interference with the antenna.
- 4) Ensure good grounding for components to minimize parasitic inductance.
- 5) Do not place copper under the module's antenna to prevent interference with signal radiation, which could affect transmission distance.
- 6) The antenna should be kept away from other circuits to maintain radiation efficiency and avoid impacting the normal operation of other circuits.
- 7) Position the module as close to the edge of the circuit board as possible, away from other circuitry.
- 8) It is recommended to use a ferrite bead for isolation when connecting the module to the power supply.



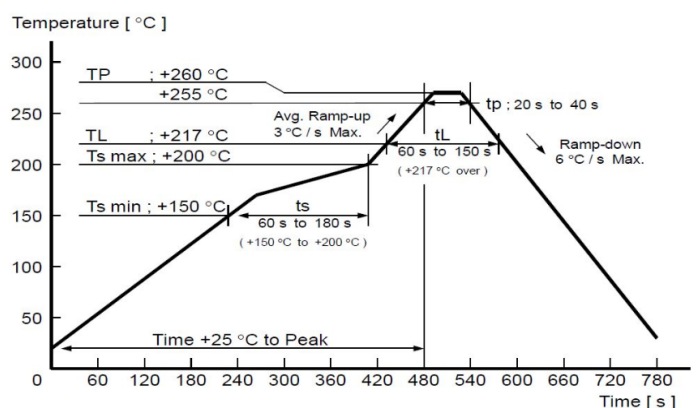
8 REFLOW AND SOLDERING

- 1) Perform SMT according to the reflow oven temperature profile provided below, with a maximum temperature of 260°C;
- 2) Follow IPC/JEDEC standards; Peak temperature: < 260°C; Number of reflows: ≤2 times; For SMT involving double-sided placement, it is recommended that the module side undergoes reflow soldering only once. For any special processes, please contact our company.

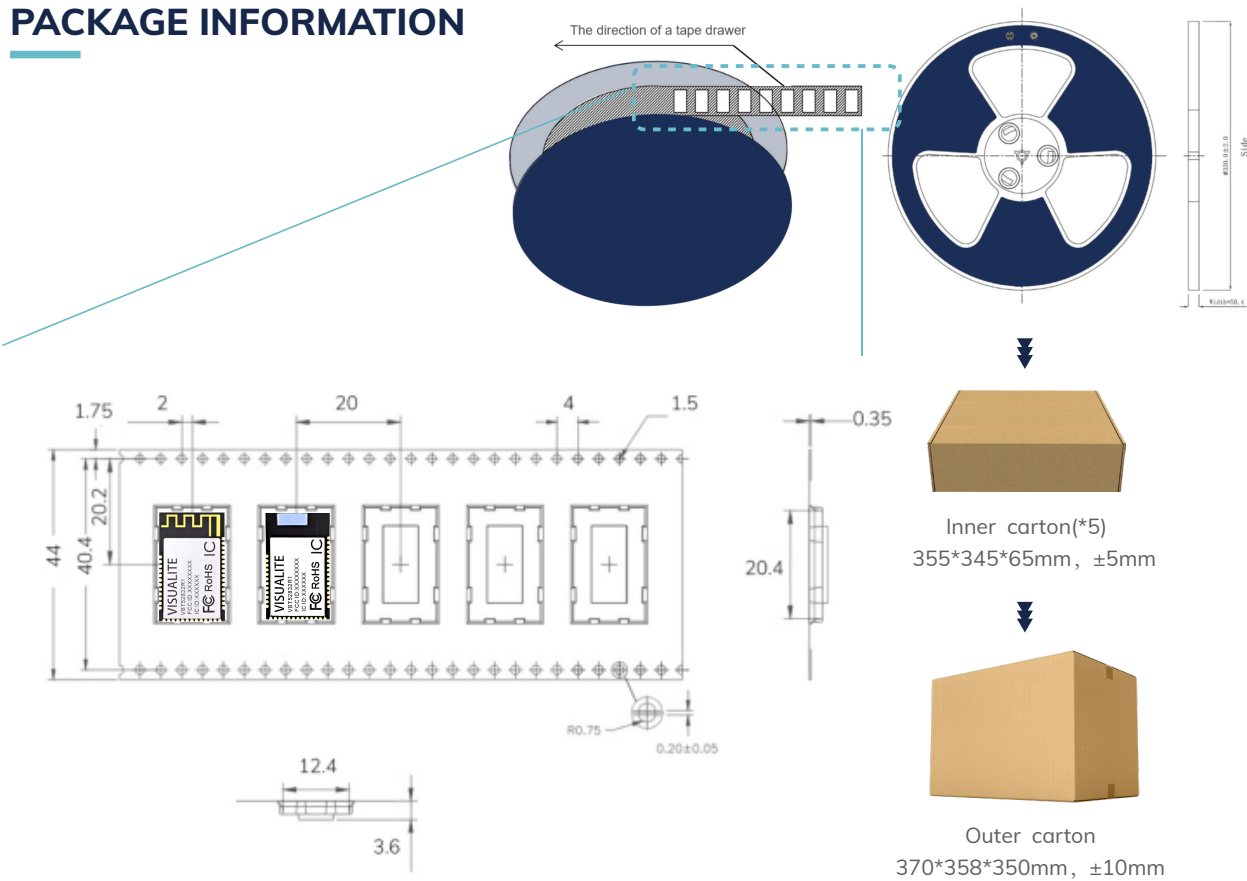
3) For module SMT, it is recommended to make the steel mesh thicker by 0.13-0.15mm, and then expand the pin length by 1-1.3mm;

4) After opening, if the entire package is not used at once, it should be stored in a vacuum to prevent long-term exposure to air, which can cause moisture absorption and pad oxidation. If there is a gap of 7 to 30 days before reuse, it is recommended to bake the tape at 65-70°C for 24 hours without unrolling it before returning to SMT.

5) ESD protection measures should be implemented before using SMT.

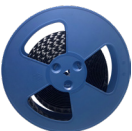


9 PACKAGE INFORMATION

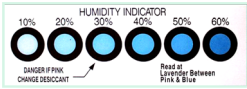


Remarks

General material list for FCL packaging:



Carrier tape packaging tray



Humidity Indicator
(1 pcs/bag)



Desiccant
(placed in a vacuum bag)



Vacuum bag



Inner carton(*5)
355*345*65mm, ±5mm



Outer carton
370*358*350mm, ±10mm

Other:

Moisture-proof label (attached to the vacuum bag)

Certification label (attached to the vacuum bag)

Outer box label



Default unit: mm Default tolerance: ±0.1

Packing detail	Specification	Net weight	Gross weight	Dimension
VB52832R	850PCS	680g	1438g	W=44mm, T=0.35mm



Note: Default weight tolerance all are within 10g (except the special notes)

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions:

- (1) This device may not cause harmful interference
- (2) This device must accept any interference received, including interference that may cause undesired operation.

10 FCC WARNING

Any Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the device.

Note: This device has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This device generates uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this device does cause harmful interference to radio or television reception, which can be determined by turning the device off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the device and receiver.
- Connect the device into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

The device has been evaluated to meet general RF exposure requirement. It can be used in portable exposure condition without restriction.

Requirement per KDB996369 D03

2.2 List of applicable FCC rules

List the FCC rules that are applicable to the modular transmitter. These are the rules that specifically establish the bands of operation, the power, spurious emissions, and operating fundamental frequencies. DO NOT list compliance to unintentional-radiator rules (Part 15 Subpart B) since that is not a condition of a module grant that is extended to a host manufacturer. See also Section 2.10 below concerning the need to notify host manufacturers that further testing is required.³Explanation: This module meets the requirements of FCC part 15C(15.247).

2.3 Summarize the specific operational use conditions

Describe use conditions that are applicable to the modular transmitter, including for example any limits on antennas, etc. For example, if point-to-point antennas are used that require reduction in power or compensation for cable loss, then this information must be in the instructions. If the use condition limitations extend to professional users, then instructions must state that this information also extends to the host manufacturer's instruction manual. In addition, certain information may also be needed, such as peak gain per frequency band and minimum gain, specifically for master devices in 5 GHz DFS bands.

Explanation: The EUT has a PCB Antenna, , and the antenna use a permanently attached Antenna which is not replaceable.

2.4 Limited module procedures

If a modular transmitter is approved as a "limited module", then the module manufacturer is responsible for approving the host environment that the limited module is used with. The manufacturer of a limited module must describe, both in the filing and in the installation instructions, the alternative means that the limited module manufacturer uses to verify that the host meets the necessary requirements to satisfy the module limiting conditions.

A limited module manufacturer has the flexibility to define its alternative method to address the conditions that limit the initial approval, such as: shielding, minimum signaling amplitude, buffered modulation/data inputs, or power supply regulation. The alternative method could include that the limited module manufacturer reviews detailed test data or host designs prior to giving the host manufacturer approval.

This limited module procedure is also applicable for RF exposure evaluation when it is necessary to demonstrate compliance in a specific host. The module manufacturer must state how control of the product into which the modular transmitter will be installed will be maintained such that full compliance of the product is always ensured. For additional hosts other than the specific host originally granted with a limited module, a Class II permissive change is required on the module grant to register the additional host as a specific host also approved with the module.

Explanation: The module is not a limited module.

2.5 Trace antenna designs

For a modular transmitter with trace antenna designs, see the guidance in Question 11 of KDB Publication 996369 D02 FAQ – Modules for Micro-Strip Antennas and traces. The integration information shall include for the TCB review the integration instructions for the following aspects: layout of trace design, parts list (BOM), antenna, connectors, and isolation requirements.

- a) Information that includes permitted variances (e.g., trace boundary limits, thickness, length, width, shape(s), dielectric constant, and impedance as applicable for each type of antenna);
- b) Each design shall be considered a different type (e.g., antenna length in multiple(s) of frequency, the wavelength, and antenna shape (traces in phase) can affect antenna gain and must be considered);
- c) The parameters shall be provided in a manner permitting host manufacturers to design the printed circuit (PC) board layout;
- d) Appropriate parts by manufacturer and specifications;
- e) Test procedures for design verification;
- f) Production test procedures for ensuring compliance.

The module grantee shall provide a notice that any deviation(s) from the defined parameters of the antenna trace, as described by the instructions, require that the host product manufacturer must notify the module grantee that they wish to change the antenna trace design. In this case, a Class II permissive change application is required to be filed by the grantee, or the host manufacturer can take responsibility through the change in FCC ID (new application) procedure followed by a Class II permissive change application.

Explanation: Yes, The module with trace antenna designs, and This manual has been shown the layout of trace design,, antenna, connectors, and isolation requirements.

2.6 RF exposure considerations

It is essential for module grantees to clearly and explicitly state the RF exposure conditions that permit a host product manufacturer to use the module. Two types of instructions are required for RF exposure information:

- (1) to the host product manufacturer, to define the application conditions (mobile, portable – xx cm from a person's body); and (2) additional text needed for the host product manufacturer to provide to end users in their end-product manuals. If RF exposure statements and use conditions are not provided, then the host product manufacturer is required to take responsibility for the module through a change in FCC ID (new application).

Explanation: This module complies with FCC RF radiation exposure limits set forth for an uncontrolled environment. This device should be installed and operated with a minimum distance of 20 centimeters between the radiator and your body." This module is designed to comply with the FCC statement, FCC ID is: 2BUG8-VBT52832R1

2.7 Antennas

A list of antennas included in the application for certification must be provided in the instructions.

For modular transmitters approved as limited modules, all applicable professional installer instructions must be included as part of the information to the host product manufacturer. The antenna list shall also identify the antenna types (monopole, PIFA, dipole, etc. (note that, for example, an “omnidirectional antenna” is not considered to be a specific “antenna type”).

For situations where the host product manufacturer is responsible for an external connector, for example, with an RF pin and antenna trace design, the integration instructions shall inform the installer that a unique antenna connector must be used on the Part 15 authorized transmitters used in the host product. The module manufacturers shall provide a list of acceptable unique connectors.

Explanation: The EUT has a PCB Antenna, and the antenna uses a permanently attached antenna, which is unique.

2.8 Label and compliance information

Grantees are responsible for the continued compliance of their modules to the FCC rules. This includes advising host product manufacturers that they need to provide a physical or e-label stating “Contains FCC ID” with their finished product. See Guidelines for Labeling and User Information for RF Devices – KDB Publication 784748.

Explanation: The host system using this module, should have label in a visible area indicated the following texts:
"Contains FCC ID: xxxxxxxx"

2.9 Information on test modes and additional testing requirements

Additional guidance for testing host products is given in KDB Publication 996369 D04 Module Integration Guide. Test modes should take into consideration different operational conditions for a stand-alone modular transmitter in a host, as well as for multiple simultaneously transmitting modules or other transmitters in a host product.

The grantee should provide information on how to configure test modes for host product evaluation for different operational conditions for a stand-alone modular transmitter in a host, versus with multiple, simultaneously transmitting modules or other transmitters in a host.

Grantees can increase the utility of their modular transmitters by providing special means, modes, or instructions that simulates or characterizes a connection by enabling a transmitter. This can greatly simplify a host manufacturer's determination that a module as installed in a host complies with FCC requirements.

Explanation: Topband can increase the utility of our modular transmitters by providing instructions that simulates or characterizes a connection by enabling a transmitter.

11 STORAGE CONDITIONS

- Please use this product within 6 months after signing the receipt.
 - This product should be stored without opening the package at an ambient temperature of 5~35°C and a humidity of 20~70%RH.
 - This product should be left for more than 6 months after receipt and should be confirmed before use.
 - The product must be stored in a non-corrosive gas (Cl₂, NH₃, SO₂, NO_x, etc.).
 - To avoid damaging the packaging material, do not apply any excessive mechanical shocks, including but not limited to sharp objects adhering to the packaging material and product dropping.
- This product is suitable for MSL2 (based on JEDEC standard J-STD-020).
 - After opening the package, the product must be stored at ≤30°C/<60%RH. It is recommended to use the product within 3-6 months after opening the package.
 - When the color of the indicator in the package changes, the product should be baked before welding.
- Baking is not required for one year if exposure is limited to <30°C and 60%RH. Refer to MSL2 for exposure criteria for moisture sensitivity level. If exposed to (≥168h@85°C/60%RH) conditions or stored for more than one year, recommended baking conditions.
 1. 120 ±5/-5°C, 8 hours, 1 timeProducts must be baked individually on heat-resistant trays because the materials (base tape, reel tape, and cover tape) are not heat-resistant, and the packaging material may be deformed at temperatures of 120 °C;
 2. 90 °C ±8/-0 °C , 24hours, 1timesThe base tape can be baked together with the product at this temperature. Please pay attention to the uniformity of heat.

12 HANDLING CONDITIONS

- Be careful in handling or transporting products because excessive stress or mechanical shock may break products.
- Handle with care if products may have cracks or damages on their terminals. If there is any such damage, the characteristics of products may change. Do not touch products with bare hands that may result in poor solder ability and destroy by static electrical charge.

13 QUALITY

Cognizant of our commitment to quality, we operate our own factory equipped with state-of-the-art production facilities and a meticulous quality management system. We hold certifications for ISO9001, ISO14001, ISO27001, OHSAS18001, BSCI.

Every product undergoes stringent testing, including transmit power, sensitivity, power consumption, stability, and aging tests. Our fully automated module production line is now in full operation, boasting a production capacity in the millions, capable of meeting high-volume production demands.

14 COPYRIGHT STATEMENT

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The certified trademarks included in this product and related documents have been licensed for use by MinewSemi. This includes but is not limited to certifications such as RoHS, CE, FCC, IC,, etc. The respective textual trademarks and logos belong to their respective owners. For example, the Bluetooth® textual trademark and logo are owned by Bluetooth SIG, Inc. Other trademarks and trade names are those of their respective owners. Due to the small size of the module product, the symbol is omitted from the Bluetooth Primary Trademarks information in compliance with regulations.

The company has the right to change the content of this manual according to the technological development, and the revised version will not be notified otherwise. Without the written permission and authorization of the company, any individual, company, or organization shall not modify the contents of this manual or use part or all of the contents of this manual in other ways. Violators will be held accountable in accordance with the law.

15 RELATED DOCUMENTS

Visualite

Innovative IoT Module
Expert

**Visualite Technology Enterprise(ShenZhen)
LTD**

 (0755)-8401-2312(822)
 Email: vs_shipping@visualitechina.com
 NO. 7, BEIGUANG INDUSTRIAL, LIANGBAI ROAD,
 EGONGLING VILLAGE, PINGHU TOWN, LONGGAN
 SHENZHEN 518111 CHINA

ISED Statement

English: This device complies with Innovation, Science and Economic Development Canada's license-exempt RSS standard(s). Operation is subject to the following two conditions: (1) This device may not cause interference, and (2) This device must accept any interference, including interference that may cause undesired operation of the device. The digital apparatus complies with Canadian CAN ICES-3 (B)/NMB-3(B).

- French: Le présent appareil est conforme aux CNR d'Innovation, sciences et développement économique Canada applicables aux appareils

radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Cet appareil numérique de la classe B est conforme à la norme NMB-003 du Canada.

Radiation Exposure Statement

This equipment complies with Canada radiation exposure limits set forth for an uncontrolled environment. This equipment should be installed and operated with minimum distance 20cm between the radiator & your body.

Déclaration d'exposition aux radiations

Cet équipement est conforme Canada limites d'exposition aux radiations dans un environnement non contrôlé.

Cet équipement doit être installé et utilisé à distance minimum de 20cm entre le radiateur et votre corps.

This radio transmitter [IC: **34991-VBT52832R1**] has been approved by Innovation, Science and Economic Development Canada to operate with the antenna types listed below, with the maximum permissible gain indicated. Antenna types not included in this list that have a gain greater than the maximum gain indicated for any type listed are strictly prohibited for use with this device.

Cet émetteur radio [IC: **34991-VBT52832R1**] a été approuvé par Innovation, sciences et développement économique Canada pour fonctionner avec les types d'antennes énumérés ci-dessous, avec le gain maximal autorisé indiqué. Les types d'antennes non inclus dans cette liste qui ont un gain supérieur au gain maximum indiqué pour tout type listé sont strictement interdits pour une utilisation avec cet appareil.

Model	Type	Connector	Peak gain (dBi)				
			2400- 2483.5MHz	5150- 5250MHz	5250- 5350MHz	5470- 5725MHz	5725- 5850MHz
VBT52832R1	PCB Antenna	/	2.50dBi	/	/	/	/
RFANT522011 QADT	Ceramic Antenna	/	3.00dBi				
VBT52832R1	Linear Antenna	/	2.50dBi				

the trace impedance must be controlled in 50Ω.

2.10 Additional testing, Part 15 Subpart B Disclaimer

This transmitter modular us tested as a subsystem and its certification does not cover the FCC Part 15 Subpart B rules requirement applicable to the final host. The final host will still need to be reassessed for compliance to this portion of rules requirements if applicable.

As long as all conditions above are met, further transmitter test will not be required. However, the OEM integrator is still responsible for testing their end-product for any additional compliance requirements required with this modular installed.

2.11 Note EMI Considerations

The OEM integrator has to be aware not to provide information to the end user regarding how to install or remove this RF module in the user's manual of the end product which integrates this module.

The host integrator must follow the integration instructions provided in this document and ensure that the composite system end product complies with the requirements by a technical assessment or evaluation to the rules and to KDB Publication 996369.

The host integrator installing this module into their product must ensure that the final composite product complies with the requirements by a technical assessment or evaluation to the rules, including the transmitter operation and should refer to guidance in KDB Publication 996369.

OEM/Host Manufacturer Responsibilities

OEM/Host manufacturers are ultimately responsible for the compliance of the Host and Module. The final product must be reassessed against all the essential requirements of the FCC rule such as FCC Part 15 Subpart B before it can be placed on the US market. This includes reassessing the transmitter module for compliance with the Radio and RF Exposure essential requirements of the FCC rules.

2.12 How to Make Changes - Important Note

In the event that these conditions cannot be met (for example certain laptop configurations or co-location with another transmitter), then the FCC authorization is no longer considered valid and the FCC ID cannot be used on the final product. In these circumstances, the OEM integrator will be responsible for re-evaluating the end product (including the transmitter) and obtaining a separate FCC authorization.